



# Product Change Notification

**Change Notification #:** 117758 - 00  
**Change Title:** MINOR CHANGE  
Packaging Change Made to Intermediate Box (I-Box) Cardboard Flaps for Closure and Intel Logo Change on i-Box, PCN 117758-00, Transport Media, Product Material, Half NSD I-Box Overlap Inner Flap design change + Logo Change  
**Date of Publication:** November 24, 2020

## Key Characteristics of the Change:

Transport Media, Product Material

## Forecasted Key Milestones:

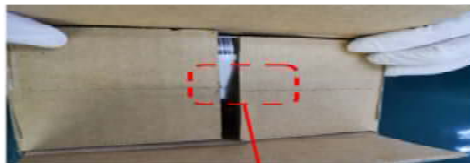
|   |                   |
|---|-------------------|
| <b>Date Customer Must be Ready to Receive Post-Conversion Material:</b> | December 24, 2020 |
|---|-------------------|

## Description of Change to the Customer:

Intel is making two changes to the intermediate box: an overlap flap design change for box closure and a change to the Intel logo displayed on intermediate boxes.

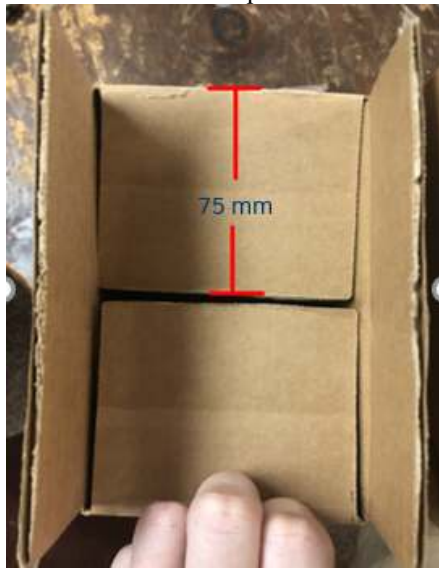
### 1) Overlap Flap on Box Design Change

This is a quality driven change in the packaging design of the intermediate box. Current Intermediate Boxes (I-Box) have a gap between the flaps where the contents of the box can be seen. (See picture below for example purposes only).

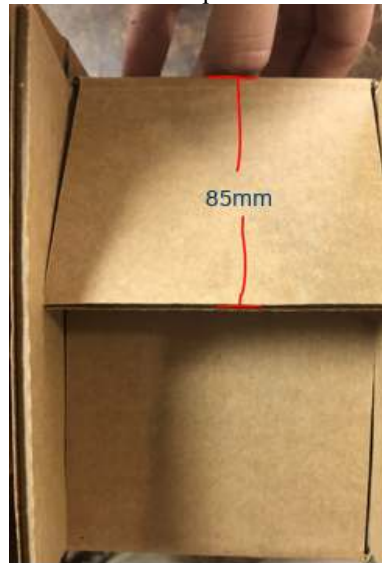


To eliminate any quality concerns with the gap in the flaps, Intel will change box designs to use an Overlap Inner Flap design. Intel will increase the flap lengths on the intermediate box from 75mm in length to 85mm in length.

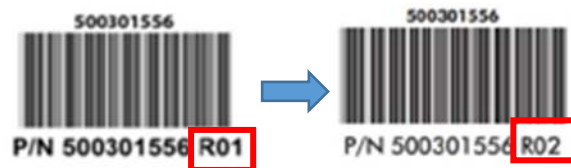
CURRENT: I-Box Flap



TO BE: I-Box Flap



As a side note, the serial number values displayed on boxes will also undergo a revision number. The serial number for both I-Box part numbers displayed on the intermediate box will go from revision "R01" to "R02".



## 2) Intel Logo on the Intermediate Box will Change

Based on recent Intel corporate logo changes, the logo placed on the I-Box will change

**Old Logo:**



**New Logo:**



### **Customer Impact of Change and Recommended Action:**

These changes are considered a Minor Change. For the Inner Flap length change, while customers will see the longer flaps used for closing the I-Box, this change will not have any impact to any contents within in the I-Box, including the bag or product itself. This change will not impact the form, fit or function of the parts inside the box. Moreover, this longer overlap will only be used on select I-Box Part Numbers IPN 500135979 and IPN 500301556.

The Logo change will also not affect products although a noticeable transport change on all Intel's intermediate boxes.

Customers should expect to see both intermediate box packaging designs until older intermediate box design inventory has been depleted.

Please contact your local Intel representative with any questions or concerns regarding the changes detailed in this notification.

### **Products Affected / Intel Ordering Codes:**

Because these changes pertain to an extensive list of products being shipped in intermediate box IPN 500135979 or IPN 500301556 they are not listed here within the standard table format. However, the file attached to this notification provides the detailed list for customers containing the MM#, S-Spec Codes and Product Codes impacted. If the part is on the Excel file attached it indicates an impact as a result of being shipped in one or both of the previously mentioned I-Boxes.

### **PCN Revision History:**

| <b>Date of Revision:</b> | <b>Revision Number:</b> | <b>Reason:</b>           |
|--------------------------|-------------------------|--------------------------|
| November 24, 2020        | 00                      | Originally Published PCN |



# Product Change Notification

## 117758 - 00

**INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

Copyright © Intel Corporation 2020. Other names and brands may be claimed as the property of others.

3D XPoint, ACEX, Altera, APEX, AnyWAN, Arria, Avalon, Axxia, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, CONVERGATE, Cyclone, Docea, eASIC, easicopy, Enpirion, Flexpipe, Hyperflex, Intel, the Intel logo, Intel Adaptix, Intel Agilex, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Falcon, Intel Inside, the Intel Inside logo, Intel Nervana, Intel Optane, Intel RealSense, Intel Shooting Star, Intel Sirius, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Iris, Itanium, MAX, Movidius, Myriad, neon, Nios, OpenVINO, the OpenVINO logo, Pentium, Puma, Quark, Quartus, SICOFL, Simics, SMARTi, SoftSilicon, Sound Mark, StarPro, Stratix, the Stratix logo, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcede, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS\* Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos. Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.